









PRODUCT DATASHEET



- ▶ PLCC2 LED
- ▶ 1608 0.6t
- ► Blue (467nm)

N0B61S54



PLCC2 1608 0.6t





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APPLICATIONS:

- Indication Light
- Switch Light
- 3C Application
- **Consumer Goods**

FEATURES:

- Package: PLCC2 Top View LED
- Forward Current: 20mA
- Forward Voltage (typ.): 3.0V
- Luminous Intensity (typ.): 330mcd@20mA
- Colour: Blue
- Wavelength (typ.): 465~470nm
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Water Clear)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.4000/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	20	mA
Peak Forward Current Duty 1/10@1KHz	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	85	mW
Electrostatics Discharge	ESD	200	V
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+100	°C

Electrical & Optical Characteristics (Ta=25°C)

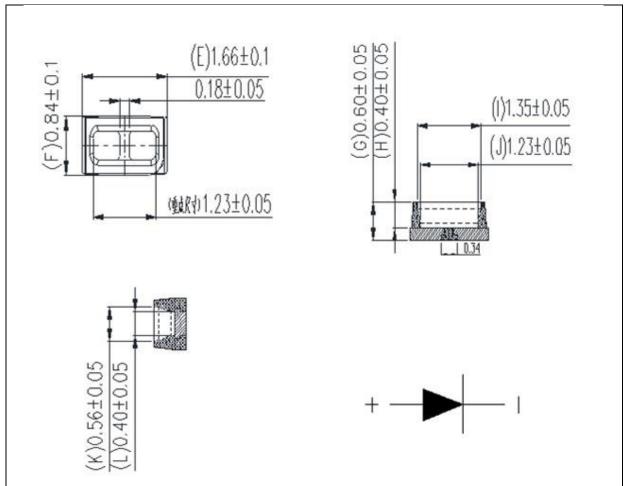
Parameter	Symbol		Values	Unit	Test Condition	
Parameter	Зуппоп	Min. Typ.		Max.		
Forward Voltage	V_{F}	2.8	3.0	3.2	V	I _F =20mA
Luminous Intensity	lv	280	330	360	mcd	I _F =20mA
Dominant Wavelength λ_D		465	467	470	nm	I _F =20mA
Peak Wavelength	λ_{P}		470		nm	I _F =20mA
Spectral Line Half Bandwidth Δ λ			45		nm	I _F =20mA
Viewing Angle 2θ _{1/2}			120		deg	I _F =20mA

^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%



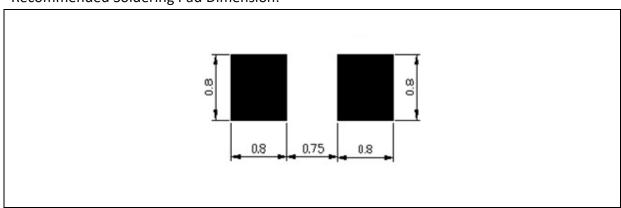
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
0	2.8	3.0	V
Р	3.0	3.2	V

Luminous Intensity Classifications (I_F = 20mA):

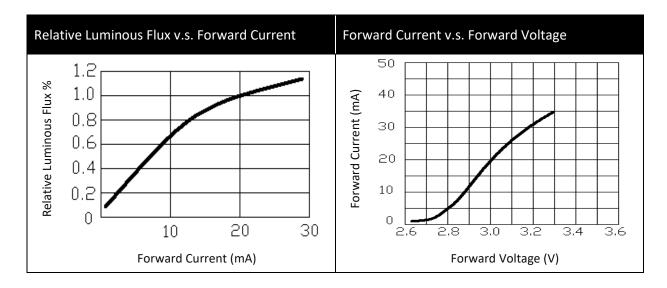
Code	Min.	Max.	Unit
1	280	360	mcd

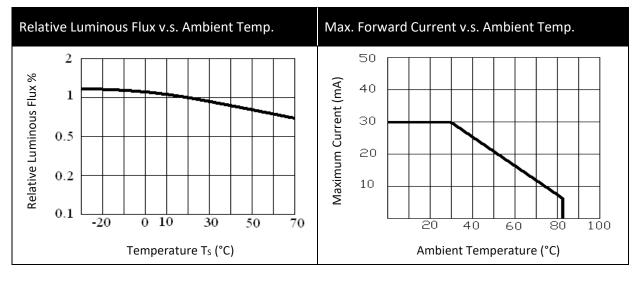
Dominant Wavelength Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
А	465	470	nm



ELECTRO-OPTICAL CHARACTERISTICS:

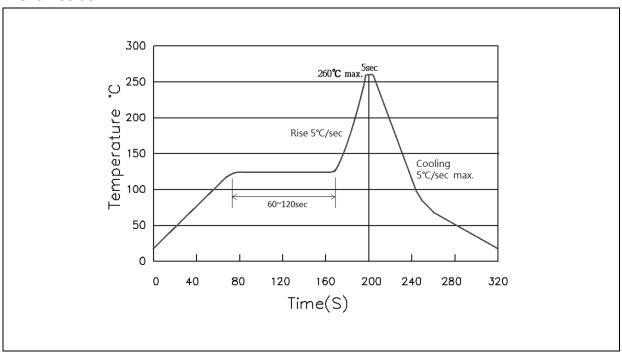






RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 1 time.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.

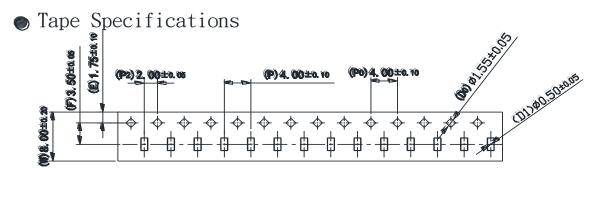


PACKING SPECIFICATION:

Reel Dimension:

Max.4000pcs/reel

	Packing Size												
Item	W	P1	Ε	F	Do	D1	Ро	10Po	P2	Ao	Во	Ko	t
Spec.	8.00	4.00	1.75	3.50	1.55	0.5	4.00	40.00	2.00	0.95	1.75	0.70	0.2
Tolerance	±0.20	±0.10	±0.10	±0.05	+0.10 -0.00	±0.05	±0.05	±0.20	±0.05	±0.10	±0.10	±0.10	±0.05





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

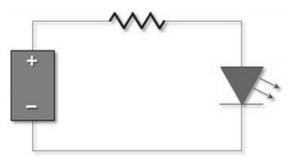
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	30/08/2022	Datasheet set-up.